

09/16/01, 824

WEST[Help](#)[Logout](#)[Interrupt](#)[Main Menu](#)[Search Form](#)[Posting Counts](#)[Show S Numbers](#)[Edit S Numbers](#)[Preferences](#)**Search Results -**

Terms	Documents
l7 and ((438/\$)!.CCLS.)	3

Database:

US Patents Full Text Database
 US Pre-Grant Publication Full-Text Database
 JPO Abstracts Database
 EPO Abstracts Database
 Derwent World Patents Index
 IBM Technical Disclosure Bulletins

17 and ((438/\$)!.CCLS.)

[Refine Search:](#)[Clear](#)**Search History****Today's Date: 12/16/2001**

<u>DB Name</u>	<u>Query</u>	<u>Hit Count</u>	<u>Set Name</u>
USPT	l7 and ((438/\$)!.CCLS.)	3	<u>L8</u>
USPT	l6 and (tape near2 bonding)	14	<u>L7</u>
USPT	l5 and wires	53	<u>L6</u>
USPT	l4 and adhesive	59	<u>L5</u>
USPT	electrode and l3	90	<u>L4</u>
USPT	l2 and (plurality near3 (through adj holes))	229	<u>L3</u>
USPT	l1 and (through adj holes)	1616	<u>L2</u>
USPT	semiconductor near2 package	6629	<u>L1</u>

WEST**Generate Collection****Search Results - Record(s) 1 through 3 of 3 returned.**

1. Document ID: US 6268648 B1

L8: Entry 1 of 3

File: USPT

Jul 31, 2001

US-PAT-NO: 6268648

DOCUMENT-IDENTIFIER: US 6268648 B1

TITLE: Board for mounting semiconductor element, method for manufacturing the same, and semiconductor device

[Full](#) [Title](#) [Citation](#) [Front](#) [Review](#) [Classification](#) [Date](#) [Reference](#) [Claims](#) [KMC](#) [Draw Desc](#) [Image](#)

2. Document ID: US 6022759 A

L8: Entry 2 of 3

File: USPT

Feb 8, 2000

US-PAT-NO: 6022759

DOCUMENT-IDENTIFIER: US 6022759 A

TITLE: Method for producing a semiconductor device, base member for semiconductor device and semiconductor device unit

[Full](#) [Title](#) [Citation](#) [Front](#) [Review](#) [Classification](#) [Date](#) [Reference](#) [Claims](#) [KMC](#) [Draw Desc](#) [Image](#)

3. Document ID: US 5804467 A

L8: Entry 3 of 3

File: USPT

Sep 8, 1998

US-PAT-NO: 5804467

DOCUMENT-IDENTIFIER: US 5804467 A

TITLE: Semiconductor device and method of producing the same

[Full](#) [Title](#) [Citation](#) [Front](#) [Review](#) [Classification](#) [Date](#) [Reference](#) [Claims](#) [KMC](#) [Draw Desc](#) [Image](#)**Generate Collection**

Terms	Documents
7 and ((438/\$)!CCLS.)	3

Documents, starting with Document:

Display Format:

WEST**Generate Collection****Search Results - Record(s) 1 through 10 of 14 returned.** 1. Document ID: US 6268648 B1

L7: Entry 1 of 14

File: USPT

Jul 31, 2001

US-PAT-NO: 6268648

DOCUMENT-IDENTIFIER: US 6268648 B1

TITLE: Board for mounting semiconductor element, method for manufacturing the same, and semiconductor device

[Full](#)[Title](#)[Citation](#)[Front](#)[Review](#)[Classification](#)[Date](#)[Reference](#)[KMC](#)[Draw Desc](#)[Image](#) 2. Document ID: US 6188127 B1

L7: Entry 2 of 14

File: USPT

Feb 13, 2001

US-PAT-NO: 6188127

DOCUMENT-IDENTIFIER: US 6188127 B1

TITLE: Semiconductor packing stack module and method of producing the same

[Full](#)[Title](#)[Citation](#)[Front](#)[Review](#)[Classification](#)[Date](#)[Reference](#)[KMC](#)[Draw Desc](#)[Image](#) 3. Document ID: US 6175151 B1

L7: Entry 3 of 14

File: USPT

Jan 16, 2001

US-PAT-NO: 6175151

DOCUMENT-IDENTIFIER: US 6175151 B1

TITLE: Film carrier tape, semiconductor assembly, semiconductor device, and method of manufacturing the same, mounted board, and electronic instrument

[Full](#)[Title](#)[Citation](#)[Front](#)[Review](#)[Classification](#)[Date](#)[Reference](#)[KMC](#)[Draw Desc](#)[Image](#) 4. Document ID: US 6120906 A

L7: Entry 4 of 14

File: USPT

Sep 19, 2000

US-PAT-NO: 6120906

DOCUMENT-IDENTIFIER: US 6120906 A

TITLE: Insulated board for a wiring board

[Full](#)[Title](#)[Citation](#)[Front](#)[Review](#)[Classification](#)[Date](#)[Reference](#)[KMC](#)[Draw Desc](#)[Image](#) 5. Document ID: US 6111306 A

L7: Entry 5 of 14

File: USPT

Aug 29, 2000

US-PAT-NO: 6111306

DOCUMENT-IDENTIFIER: US 6111306 A

TITLE: Semiconductor device and method of producing the same and semiconductor device unit and method of producing the same

[Full](#)[Title](#)[Citation](#)[Front](#)[Review](#)[Classification](#)[Date](#)[Reference](#)[KMC](#)[Draw Desc](#)[Image](#) 6. Document ID: US 6022759 A

L7: Entry 6 of 14

File: USPT

Feb 8, 2000

US-PAT-NO: 6022759

DOCUMENT-IDENTIFIER: US 6022759 A

TITLE: Method for producing a semiconductor device, base member for semiconductor device and semiconductor device unit

[Full](#)[Title](#)[Citation](#)[Front](#)[Review](#)[Classification](#)[Date](#)[Reference](#)[KMC](#)[Draw Desc](#)[Image](#) 7. Document ID: US 5866942 A

L7: Entry 7 of 14

File: USPT

Feb 2, 1999

US-PAT-NO: 5866942

DOCUMENT-IDENTIFIER: US 5866942 A

TITLE: Metal base package for a semiconductor device[Full](#)[Title](#)[Citation](#)[Front](#)[Review](#)[Classification](#)[Date](#)[Reference](#)[KMC](#)[Draw Desc](#)[Image](#) 8. Document ID: US 5820014 A

L7: Entry 8 of 14

File: USPT

Oct 13, 1998